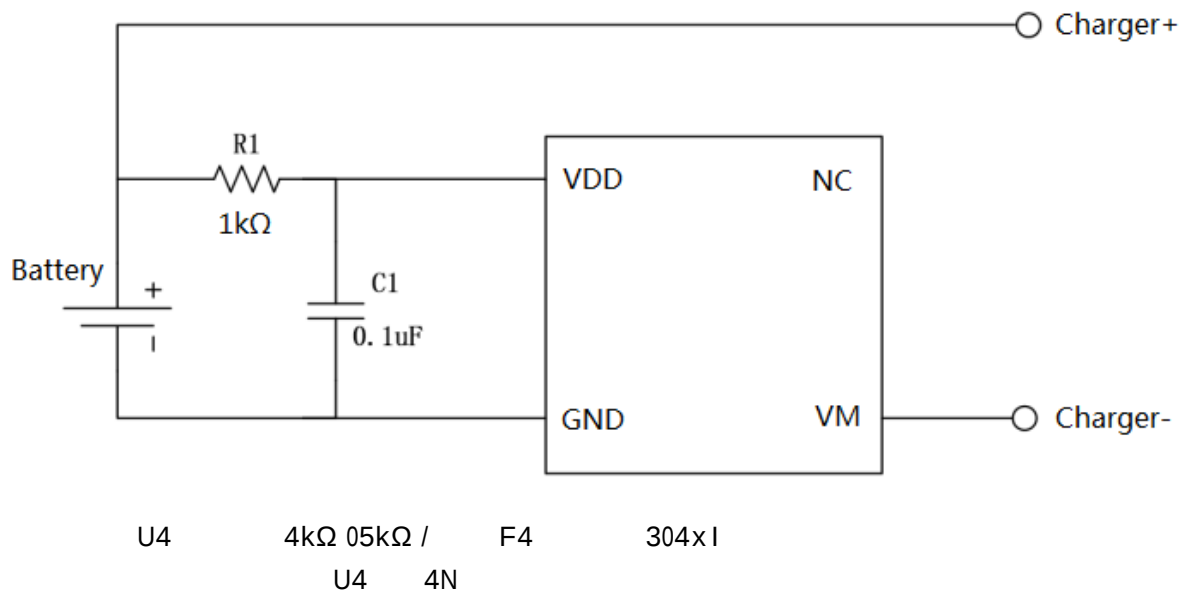
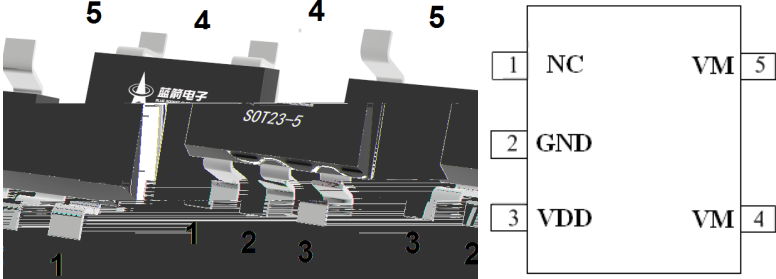


EUF06463G P H P R V I H W
P R V I H W

EUF06463G P H V R W 5 6 0 8

- ◆ 49 p Ω P R V I H W
- ◆ V R W 5 6 0 8
- ◆
- ◆
- ◆ 618 μD
- ◆ 319 μD
- ◆





1	NC	VM	5
2	GND		
3	VDD	VM	4

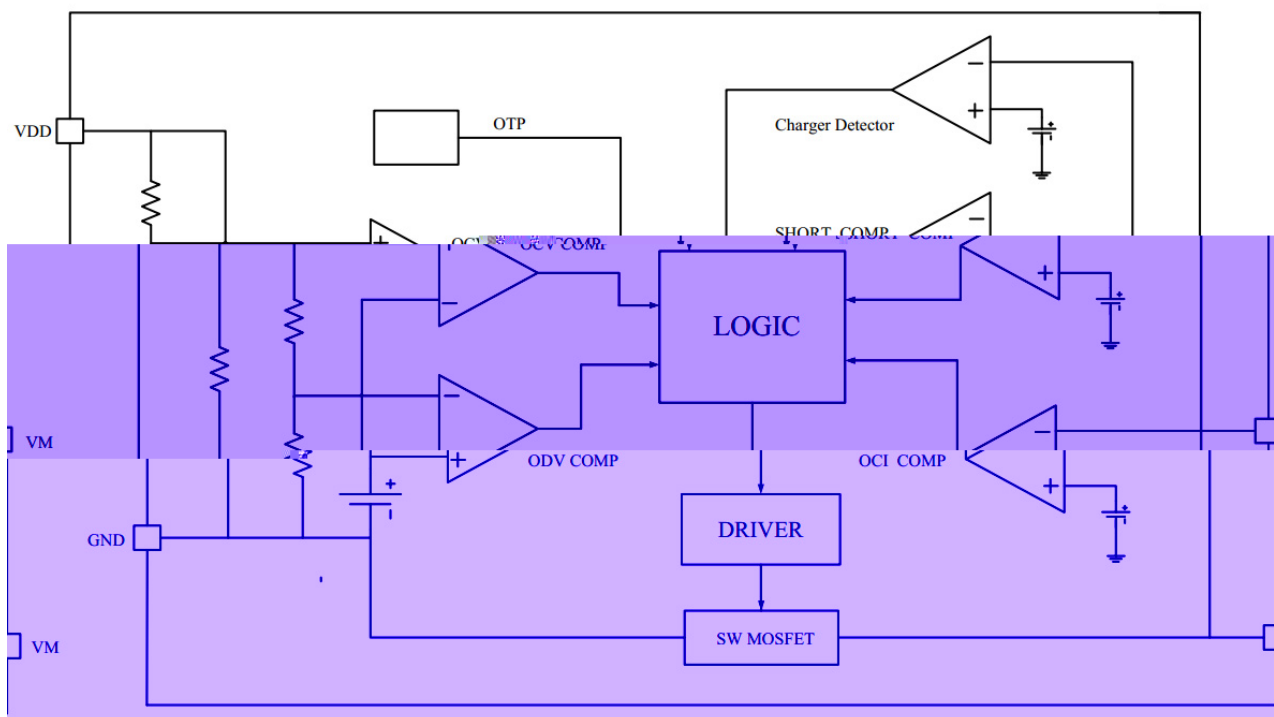
Siq Qx p ee u	Siq Qd p e	Siq Gefuiswi r q
4	NC	
5	JQG	
6	VDD	
7/8	VP	

See Marking Instructions.

/Parameter	/Symbol	/Value	/Unit
V _{DD} input pin voltage	V _{IN}	-0.3 to +8	V
V _{VM} input pin voltage	V _{VM}	-8 to +10	V
Maximum Junction Temperature	T _J	-40 to +145	
Storage Temperature	T _{stg}	-55 to +145	
Power Dissipation	P _D (T _C)		

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Over-temperature protection	OTP			145		
Over-temperature protection release temperature	OTPR			120		
Overcharge Voltage Detection Delay Time	T _{OCV}			100		ms
Overdischarge Voltage Detection Delay Time	T _{ODV}			100		ms
Overdischarge Current1 Detection Delay Time	T _{IOV1}			8		ms
Overdischarge Current2 Detection Delay Time	T _{IOV2}			2		ms
Load Short-Circuiting Detection Delay Time	T _{SHORT}			150		μs

/



/

EUF06463G PH

P RVIHW49 p Ω

EUF06463G PH

/

/

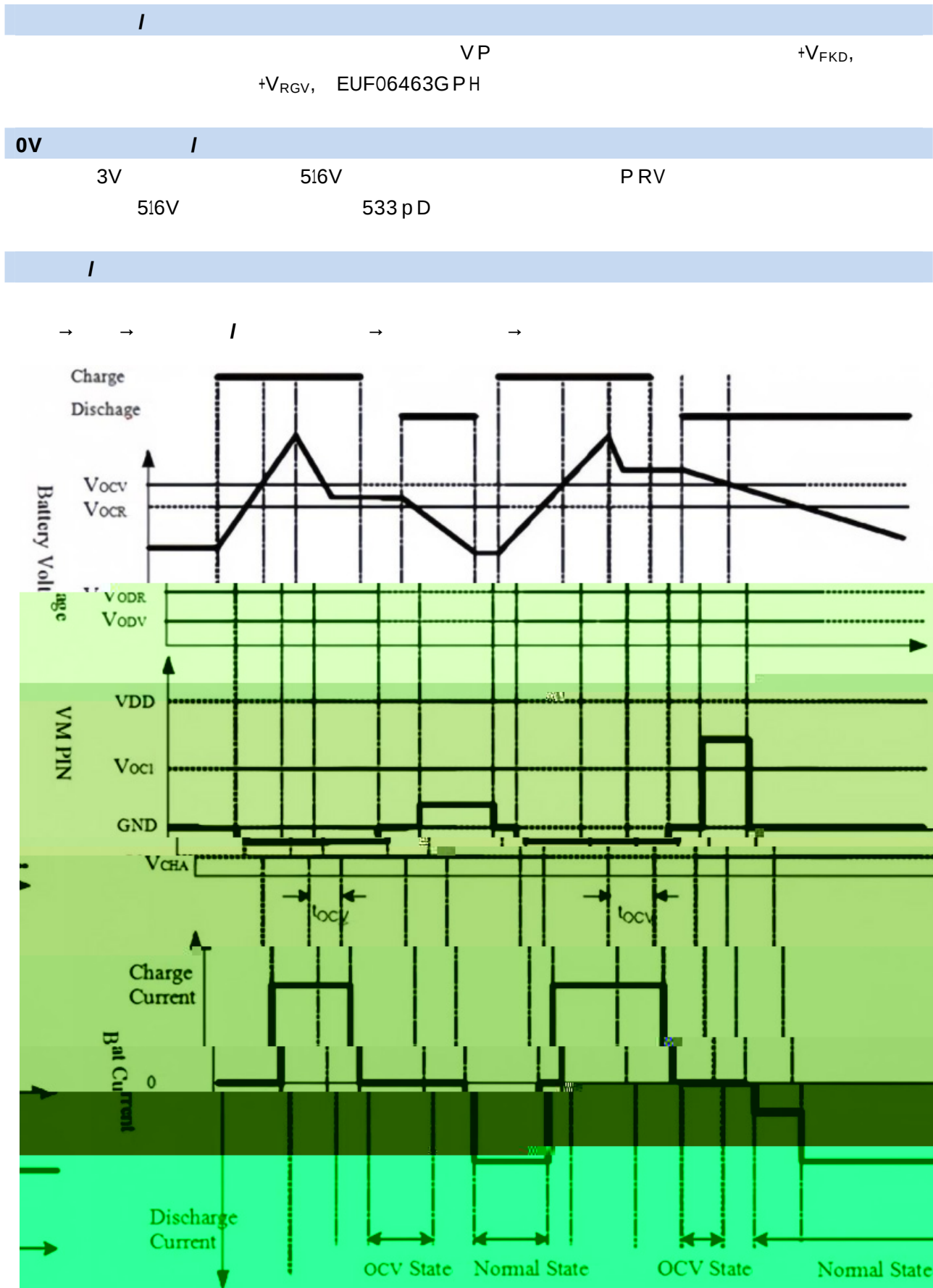
+V_{RFV},

+W_{RFV},EUF06463G PHP RVIHW

+W_{RFV},

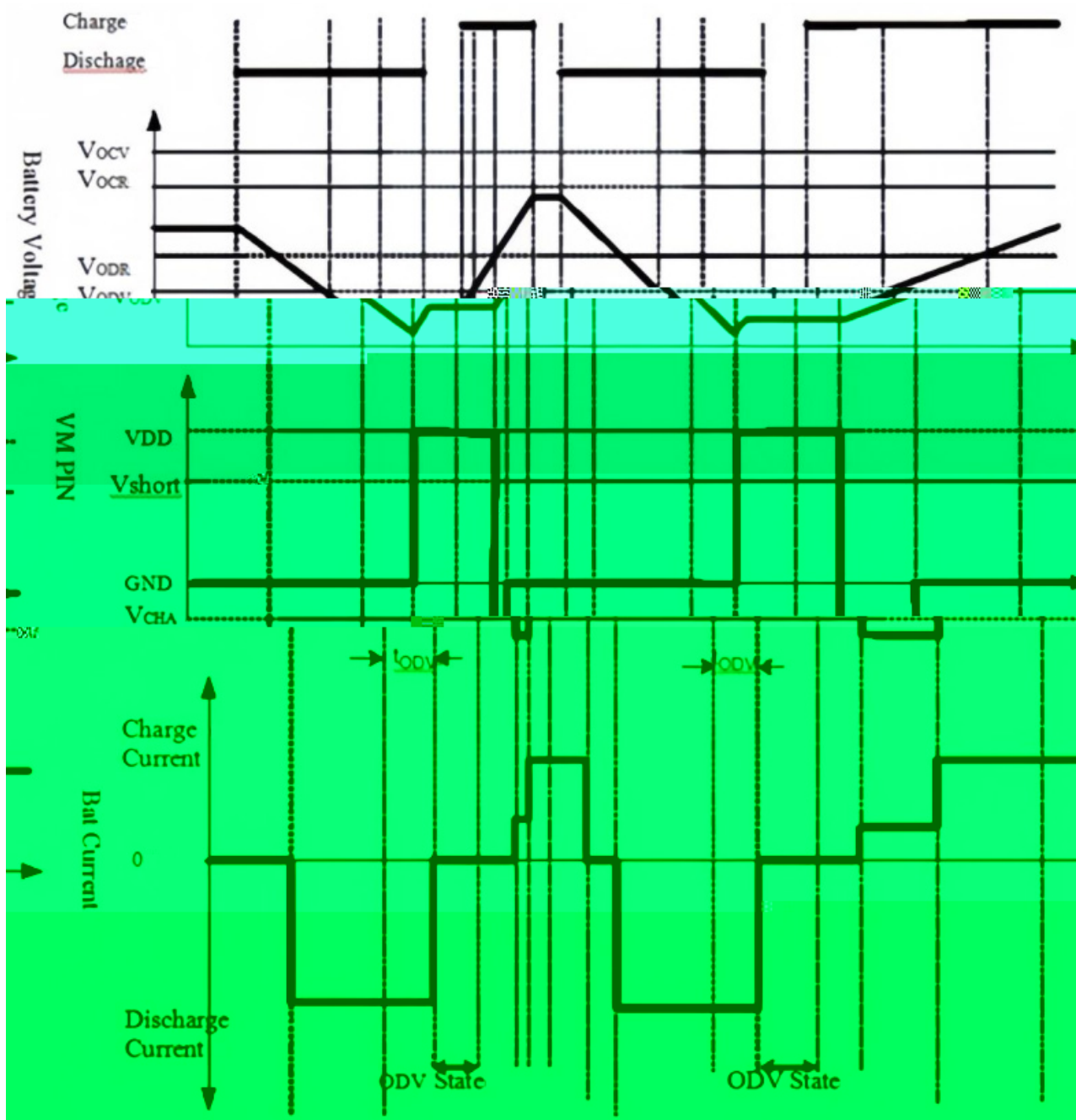
4VP+V_{EKD},+V_{RFU},

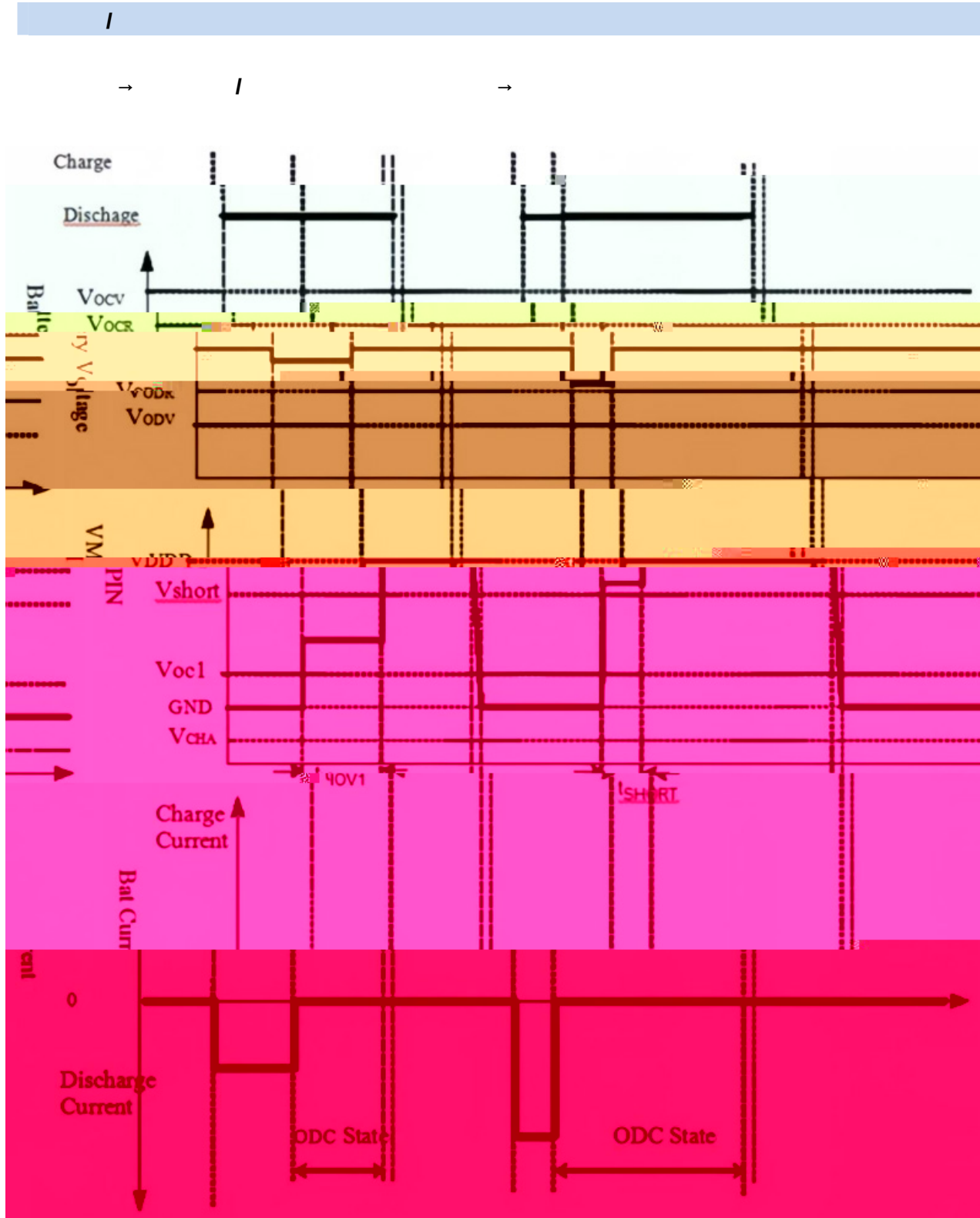
5+V_{r fy},

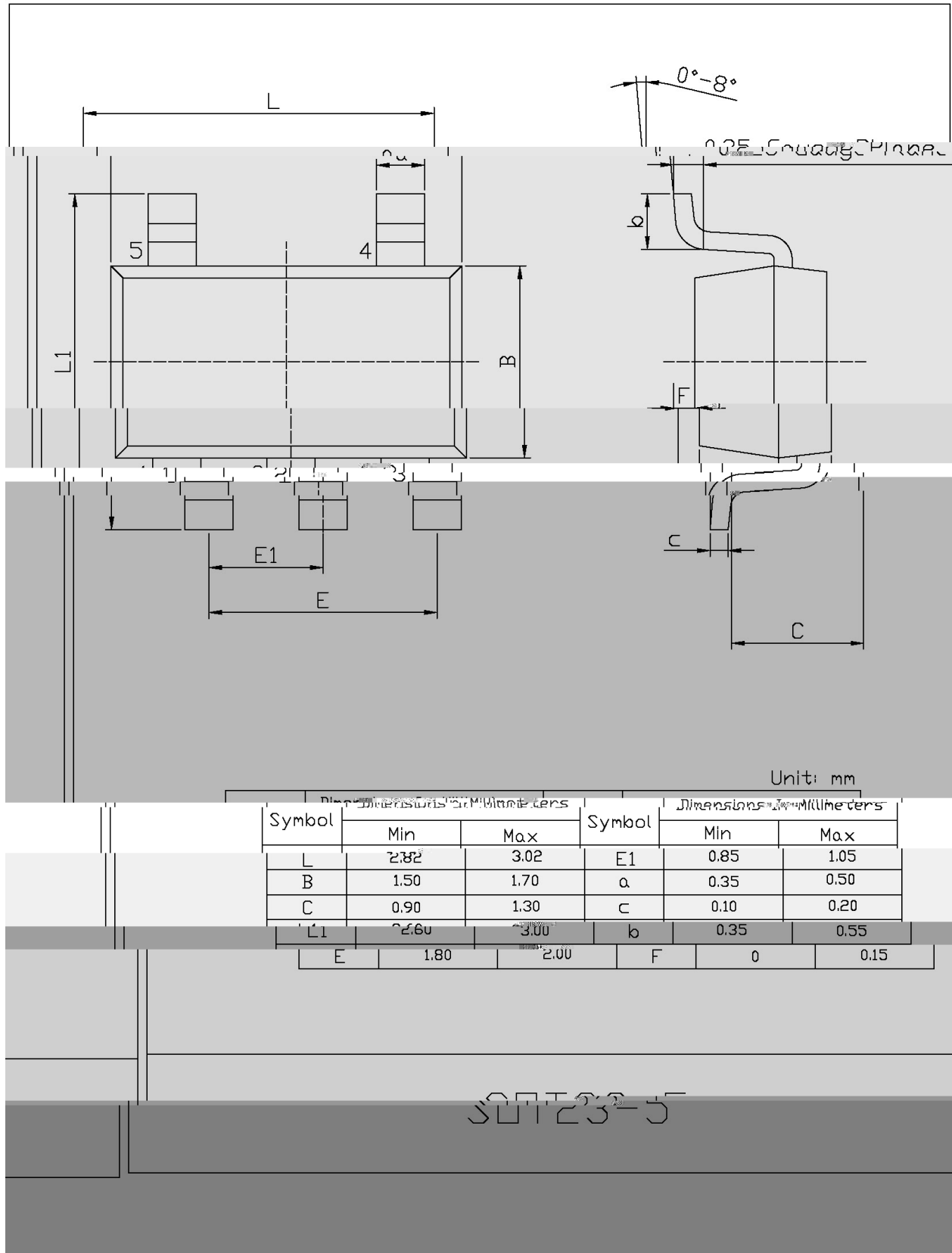


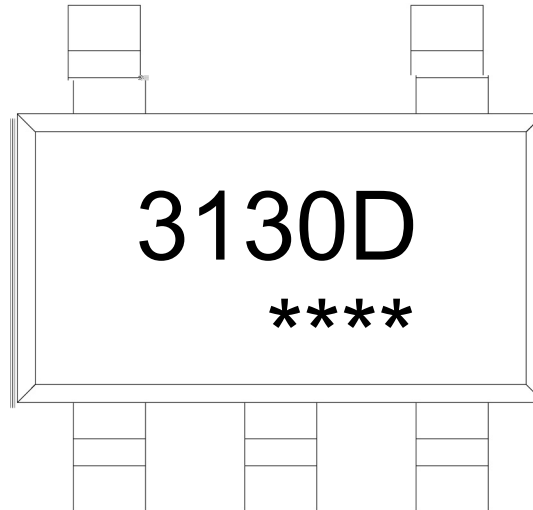
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→ → / → →









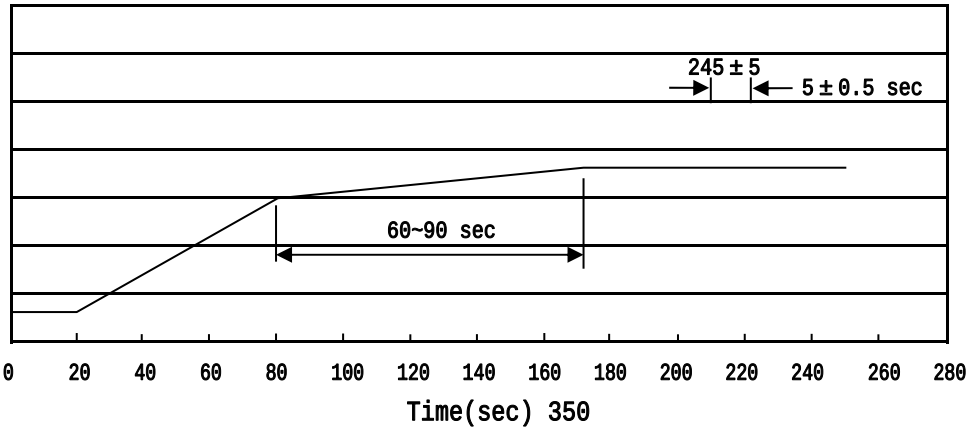
6463G

Note:

3130D: Product Type Code

****: Lot No. Code, code change with Lot No.

Temperature Profile for IR Reflow Soldering(Pb-Free)



- 1

150 180

60 90sec;

250
- 2

245±5

5±0.5sec;

200
- 3

2 10 /sec.

150

- Note:
- 1.Preheating:150~180 , Time:60~90sec.
- 2.Peak Temp.:245±5 , Duration:5±0.5sec.
3. Cooling Speed: 2~10 /sec.

260±5

10±1 sec.

50

Temp.:260±5

Time:10±1 sec

0

/ REEL

Package Type	Units					Dimension (unit mm ³)		
	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Reel	Inner Box	Outer Box
SOT23-5/6	3,000	10	30,000	4	120,000	7 ×8	210×205×205	445×435×230

Temperature()